## **SIEMENS**

## **Data sheet**

## 6ES7513-1AM03-0AB0



SIMATIC S7-1500, CPU 1513-1 PN, central processing unit with work memory 600 KB for program and 2.5 MB for data, 1st interface: PROFINET IRT with 2-port switch, 25 ns bit performance, SIMATIC Memory Card required - - approvals and certificates according to entry 109815653 at support.industry.siemens.com to be considered! - -

General information	
Product type designation	CPU 1513-1 PN
HW functional status	FS03
Firmware version	V3.1
FW update possible	Yes
Product function	
■ I&M data	Yes; I&M0 to I&M3
• Isochronous mode	Yes; Distributed and central; with minimum OB 6x cycle of 500 $\mu s$ (distributed) and 1 ms (central)
SysLog	Yes
Engineering with	
STEP 7 TIA Portal configurable/integrated from version	V19 (FW V3.1) / V18 (FW V3.0) or higher; with older TIA Portal versions configurable as 6ES7513-1AL02-0AB0
Configuration control	
via dataset	Yes
Display	
Screen diagonal [cm]	3.45 cm
Control elements	
Number of keys	8
Mode buttons	2
Supply voltage	
Rated value (DC)	24 V
permissible range, lower limit (DC)	19.2 V
permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Mains buffering	
<ul> <li>Mains/voltage failure stored energy time</li> </ul>	5 ms
<ul> <li>Repeat rate, min.</li> </ul>	1/s
Input current	
Current consumption (rated value)	0.56 A
Current consumption, max.	0.9 A
Inrush current, max.	1.15 A; Rated value
l²t	0.6 A <sup>2</sup> ·s
Power	
Infeed power to the backplane bus	10 W
Power consumption from the backplane bus (balanced)	5.5 W
Power loss	
Power loss, typ.	3.4 W
Memory	
Number of slots for SIMATIC memory card	1

SIMATIC memory card required	Yes
Work memory	
<ul><li>integrated (for program)</li></ul>	600 kbyte
<ul><li>integrated (for data)</li></ul>	2.5 Mbyte
Load memory	
<ul> <li>Plug-in (SIMATIC Memory Card), max.</li> </ul>	32 Gbyte
Backup	
maintenance-free	Yes
CPU processing times	
for bit operations, typ.	25 ns
for word operations, typ.	32 ns
	42 ns
for fixed point arithmetic, typ.	
for floating point arithmetic, typ.	170 ns
CPU-blocks	
Number of elements (total)	4 000; Blocks (OB, FB, FC, DB) and UDTs
DB	
Number range	1 60 999; subdivided into: number range that can be used by the user: 1
Oine man	59 999, and number range of DBs created via SFC 86: 60 000 60 999
• Size, max.	2.5 Mbyte; For DBs with absolute addressing, the max. size is 64 KB
FB	
Number range	0 65 535
• Size, max.	600 kbyte
FC	
Number range	0 65 535
• Size, max.	600 kbyte
ОВ	
• Size, max.	600 kbyte
<ul> <li>Number of free cycle OBs</li> </ul>	100
<ul> <li>Number of time alarm OBs</li> </ul>	20
<ul> <li>Number of delay alarm OBs</li> </ul>	20
Number of cyclic interrupt OBs	20; With minimum OB 3x cycle of 250 μs
Number of process alarm OBs	50
Number of DPV1 alarm OBs	3
Number of isochronous mode OBs	2
Number of technology synchronous alarm OBs	2
Number of startup OBs	100
Number of startup OBs     Number of asynchronous error OBs	
•	4
Number of synchronous error OBs	2
Number of diagnostic alarm OBs	1
Nesting depth	
per priority class	24
Counters, timers and their retentivity	
S7 counter	
Number	2 048
Retentivity	
— adjustable	Yes
IEC counter	
Number	Any (only limited by the main memory)
Retentivity	
— adjustable	Yes
S7 times	
Number	2 048
Retentivity	
— adjustable	Yes
IEC timer	
• Number	Any (only limited by the main memory)
	Tary (only infliced by the main memory)
Retentivity	Von
— adjustable	Yes
Data areas and their retentivity	
Retentive data area (incl. timers, counters, flags), max.	256 kbyte; in total; available retentive memory for bit memories, timers, counters, DBs, and technology data (axes): 216 KB

Extended retentive data area (incl. timers, counters, flags), max.	2.5 Mbyte; When using PS 6 0W 24/48/60 V DC HF
Flag	4011
• Size, max.	16 kbyte
Number of clock memories	8; 8 clock memory bit, grouped into one clock memory byte
Data blocks	W
Retentivity adjustable	Yes
Retentivity preset	No
Local data	CA librates many 40 I/D new block
per priority class, max.  Address area	64 kbyte; max. 16 KB per block
Number of IO modules	2 048; max. number of modules / submodules
I/O address area	
• Inputs	32 kbyte; All inputs are in the process image
• Outputs	32 kbyte; All outputs are in the process image
per integrated IO subsystem	
— Inputs (volume)	8 kbyte
— Outputs (volume)	8 kbyte
per CM/CP	
— Inputs (volume)	8 kbyte
— Outputs (volume)	8 kbyte
Subprocess images	,
Number of subprocess images, max.	32
Hardware configuration	
Number of distributed IO systems	32; A distributed I/O system is characterized not only by the integration of
Number of distributed to systems	distributed I/O via PROFINET or PROFIBUS communication modules, but also by the connection of I/O via AS-i master modules or links (e.g. IE/PB-Link)
Number of DP masters	
• Via CM	6; A maximum of 6 CMs (PROFINET + PROFIBUS) can be inserted in total
Number of IO Controllers	
• integrated	1
• Via CM	6; A maximum of 6 CMs (PROFINET + PROFIBUS) can be inserted in total
Rack	
<ul> <li>Modules per rack, max.</li> </ul>	32; CPU + 31 modules
<ul> <li>Number of lines, max.</li> </ul>	1
PtP CM	
Number of PtP CMs	the number of connectable PtP CMs is only limited by the number of available slots
Fime of day	
Clock	
	Hardware clock
Clock	
Clock  Type  Backup time Deviation per day, max.	Hardware clock
Clock  Type Backup time	Hardware clock 6 wk; At 40 °C ambient temperature, typically
Clock  Type  Backup time Deviation per day, max.  Operating hours counter Number	Hardware clock 6 wk; At 40 °C ambient temperature, typically
Clock  Type  Backup time  Deviation per day, max.  Operating hours counter	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s
Clock  Type  Backup time Deviation per day, max.  Operating hours counter Number	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s
Clock  Type Backup time Deviation per day, max. Operating hours counter Number Clock synchronization	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s
Clock  Type Backup time Deviation per day, max. Operating hours counter Number Clock synchronization supported	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter Number  Clock synchronization supported to DP, master	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP
Clock  Type Backup time Deviation per day, max.  Operating hours counter Number  Clock synchronization supported to DP, master on DP, device	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP
Clock  Type Backup time Deviation per day, max.  Operating hours counter Number  Clock synchronization supported to DP, master on DP, device in AS, master	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter  Number  Clock synchronization supported to DP, master on DP, device in AS, master in AS, device	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter Number  Clock synchronization supported to DP, master on DP, device in AS, master in AS, device on Ethernet via NTP	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter  Number  Clock synchronization  supported to DP, master on DP, device in AS, master in AS, device on Ethernet via NTP	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes Yes Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter  Number  Clock synchronization  supported to DP, master on DP, device in AS, master in AS, device on Ethernet via NTP	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes Yes Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter  Number Clock synchronization supported to DP, master on DP, device in AS, master in AS, device on Ethernet via NTP	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes Yes Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter  Number  Clock synchronization supported to DP, master on DP, device in AS, master in AS, device on Ethernet via NTP  Interfaces  Number of PROFINET interfaces  Interface types	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes Yes Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter  Number  Clock synchronization  supported to DP, master on DP, device in AS, master in AS, device on Ethernet via NTP  Interfaces  Number of PROFINET interfaces  Interface types RJ 45 (Ethernet) Number of ports	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes Yes Yes Yes Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter  Number  Clock synchronization  supported to DP, master on DP, device in AS, master in AS, device on Ethernet via NTP  Interfaces  Number of PROFINET interfaces  Interface types RJ 45 (Ethernet)	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes Yes Yes Yes Yes
Clock  Type Backup time Deviation per day, max.  Operating hours counter  Number  Clock synchronization  supported to DP, master on DP, device in AS, master in AS, device on Ethernet via NTP  Interfaces  Number of PROFINET interfaces  Interface types RJ 45 (Ethernet) Number of ports integrated switch	Hardware clock 6 wk; At 40 °C ambient temperature, typically 10 s; Typ.: 2 s  16  Yes Yes; via PROFIBUS CM / CP Yes; via PROFIBUS CM / CP Yes Yes Yes Yes Yes Yes

Yes PROFINET IO Device • SIMATIC communication Yes • Open IE communication Yes; Optionally also encrypted Web server Yes Media redundancy Yes **PROFINET IO Controller** Services - Isochronous mode Yes - Direct data exchange Yes; Requirement: IRT and isochronous mode (MRPD optional) - IRT PROFlenergy Yes; per user program Prioritized startup Yes; Max. 32 PROFINET devices - Number of connectable IO Devices, max. 128; In total, up to 512 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET - Of which IO devices with IRT, max. 64 128 - Number of connectable IO Devices for RT, max. - of which in line, max. - Number of IO Devices that can be simultaneously 8: in total across all interfaces activated/deactivated, max. - Number of IO Devices per tool, max. 8 - Updating times The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data - PROFINET Security Class Update time for IRT — for send cycle of 250 µs  $250\;\mu\text{s}$  to 4 ms; Note: In the case of IRT with isochronous mode, the minimum update time of 500  $\mu s$  of the isochronous OB is decisive — for send cycle of 500 µs 500 µs to 8 ms — for send cycle of 1 ms 1 ms to 16 ms 2 ms to 32 ms - for send cycle of 2 ms - for send cycle of 4 ms 4 ms to 64 ms - With IRT and parameterization of "odd" send cycles Update time = set "odd" send clock (any multiple of 125  $\mu$ s: 375  $\mu$ s, 625  $\mu$ s ... 3 875 µs) Update time for RT - for send cycle of 250 µs 250 µs to 128 ms — for send cycle of 500 µs 500 µs to 256 ms — for send cycle of 1 ms 1 ms to 512 ms - for send cycle of 2 ms 2 ms to 512 ms - for send cycle of 4 ms 4 ms to 512 ms **PROFINET IO Device** Services - Isochronous mode Nο - IRT Yes - PROFlenergy Yes; per user program - Shared device Yes - Number of IO Controllers with shared device, max. 4 - activation/deactivation of I-devices Yes; per user program - Asset management record Yes; per user program - PROFINET Security Class SNMP Configuration and DCP Read Only Interface types RJ 45 (Ethernet) • 100 Mbps Yes Autonegotiation Yes Autocrossing Yes • Industrial Ethernet status LED Yes Protocols **PROFIsafe** No Number of connections • Number of connections, max. 128; via integrated interfaces of the CPU and connected CPs / CMs 10 • Number of connections reserved for ES/HMI/web • Number of connections via integrated interfaces 88 • Number of S7 routing paths 16

Redundancy mode	
H-Sync forwarding	Yes
Media redundancy	
— Media redundancy	only via 1st interface (X1)
— MRP	Yes; MRP Automanager according to IEC 62439-2 Edition 2.0, MRP Manager; MRP Client
- MRP interconnection, supported	Yes; as MRP ring node according to IEC 62439-2 Edition 3.0
— MRPD	Yes; Requirement: IRT
Switchover time on line break, typ.	200 ms; For MRP, bumpless for MRPD
Number of stations in the ring, max.	50
SIMATIC communication	
PG/OP communication	Yes; encryption with TLS V1.3 pre-selected
• S7 routing	Yes
· ·	Yes
Data record routing     S7 communication, as conver	Yes
S7 communication, as server	
S7 communication, as client	Yes
User data per job, max.	See online help (S7 communication, user data size)
Open IE communication	v
• TCP/IP	Yes
— Data length, max.	64 kbyte
— several passive connections per port, supported	Yes
• ISO-on-TCP (RFC1006)	Yes
— Data length, max.	64 kbyte
• UDP	Yes
— Data length, max.	2 kbyte; 1 472 bytes for UDP broadcast
<ul><li>UDP multicast</li></ul>	Yes; max. 78 multicast circuits
• DHCP	Yes
• DNS	Yes
• SNMP	Yes
• DCP	Yes
• LLDP	Yes
Encryption	Yes; Optional
Web server	
• HTTP	Yes; Standard and user pages
• HTTPS	Yes; Standard and user pages
• web API	
<ul><li>Number of sessions, max.</li></ul>	50
— number of simultaneous HTTP calls, max.	4
— HTTP request body, max.	131 072 byte
OPC UA	
Runtime license required	Yes; "Small" license required
OPC UA Client	Yes; Data Access (registered Read/Write), Method Call
Application authentication	Yes
Security policies	Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
— User authentication	"anonymous" or by user name & password
Number of connections, max.	4
Number of connections, max.      Number of nodes of the client interfaces, recommended max.	1 000
recommended flax.	
<ul><li>— Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_I</li></ul>	300
— Number of elements for one call of	
<ul> <li>— Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_I max.</li> <li>— Number of elements for one call of</li> </ul>	
<ul> <li>Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_I max.</li> <li>Number of elements for one call of OPC_UA_NameSpaceGetIndexList, max.</li> <li>Number of elements for one call of</li> </ul>	20
<ul> <li>Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_I max.</li> <li>Number of elements for one call of OPC_UA_NameSpaceGetIndexList, max.</li> <li>Number of elements for one call of OPC_UA_MethodGetHandleList, max.</li> <li>Number of simultaneous calls of the client instructions for session management, per connection,</li> </ul>	20 100
<ul> <li>Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_I max.</li> <li>Number of elements for one call of OPC_UA_NameSpaceGetIndexList, max.</li> <li>Number of elements for one call of OPC_UA_MethodGetHandleList, max.</li> <li>Number of simultaneous calls of the client instructions for session management, per connection, max.</li> <li>Number of simultaneous calls of the client</li> </ul>	20 100 1

<ul> <li>— Number of inputs/outputs when calling</li> <li>OPC UA MethodCall, max.</li> </ul>	20
OPC UA Server	Yes; Data Access (Read, Write, Subscribe), Method Call, Alarms & Condition (A&C), Custom Address Space
<ul> <li>Application authentication</li> </ul>	Yes
— Security policies	available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256, Aes128Sha256RsaOaep, Aes256Sha256RsaPss
<ul> <li>User authentication</li> </ul>	"anonymous" or by user name & password
<ul> <li>— GDS support (certificate management)</li> </ul>	Yes
— Number of sessions, max.	32
<ul> <li>Number of accessible variables, max.</li> </ul>	50 000
<ul> <li>Number of registerable nodes, max.</li> </ul>	10 000
Number of subscriptions per session, max.	50
— Sampling interval, min.	100 ms
— Publishing interval, min.	200 ms
Number of server methods, max.	20
Number of inputs/outputs per server method, max.	20
Number of impuls/outputs per server method, max.      Number of monitored items, recommended max.	4 000; for 1 s sampling interval and 1 s send interval
— Number of server interfaces, max.	10 of each "Server interfaces" / "Companion specification" type and 20 of the type "Reference namespace"
<ul> <li>Number of nodes for user-defined server interfaces, max.</li> </ul>	15 000
Alarms and Conditions	Yes
Number of program alarms	100
Number of program aranis      Number of alarms for system diagnostics	50
Further protocols	30
MODBUS	Yes; MODBUS TCP
	Tes, MODBOS TCP
S7 message functions	00
Number of login stations for message functions, max.	32
number of subscriptions, max.	250
number of tags/attributes for subscriptions, max.	2 000
Program alarms	Yes
Number of configurable program messages, max.	5 000; Program messages are generated by the "Program_Alarm" block, ProDiag or GRAPH
Number of loadable program messages in RUN, max.	5 000
Number of simultaneously active program alarms	
<ul> <li>Number of program alarms</li> </ul>	600
<ul> <li>Number of alarms for system diagnostics</li> </ul>	100
<ul> <li>Number of alarms for motion technology objects</li> </ul>	160
Test commissioning functions	
Test commissioning functions  Joint commission (Team Engineering)	Yes; Parallel online access possible for up to 5 engineering systems
· · · · · · · · · · · · · · · · · · ·	Yes; Parallel online access possible for up to 5 engineering systems Yes; Up to 8 simultaneously (in total across all ES clients)
Joint commission (Team Engineering)	
Joint commission (Team Engineering) Status block	Yes; Up to 8 simultaneously (in total across all ES clients)
Joint commission (Team Engineering) Status block Single step	Yes; Up to 8 simultaneously (in total across all ES clients) No
Joint commission (Team Engineering) Status block Single step Number of breakpoints	Yes; Up to 8 simultaneously (in total across all ES clients) No 8
Joint commission (Team Engineering) Status block Single step Number of breakpoints Profiling	Yes; Up to 8 simultaneously (in total across all ES clients) No 8
Joint commission (Team Engineering) Status block Single step Number of breakpoints Profiling Status/control  • Status/control variable	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  • Status/control variable  • Variables	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes
Joint commission (Team Engineering) Status block Single step Number of breakpoints Profiling Status/control  • Status/control variable • Variables • Number of variables, max.	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters
Joint commission (Team Engineering) Status block Single step Number of breakpoints Profiling Status/control  • Status/control variable • Variables • Number of variables, max. — of which status variables, max.	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job
Joint commission (Team Engineering) Status block Single step Number of breakpoints Profiling Status/control  • Status/control variable • Variables • Number of variables, max. — of which status variables, max. — of which control variables, max.	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters
Joint commission (Team Engineering) Status block Single step Number of breakpoints Profiling Status/control  • Status/control variable • Variables • Number of variables, max. — of which status variables, max. — of which control variables, max. Forcing	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job 200; per job
Joint commission (Team Engineering) Status block Single step Number of breakpoints Profiling Status/control  • Status/control variable • Variables • Number of variables, max. — of which status variables, max. — of which control variables, max. Forcing • Forcing	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job 200; per job
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  • Status/control variable  • Variables  • Number of variables, max.  — of which status variables, max.  — of which control variables, max.  Forcing  • Forcing  • Forcing, variables	Yes; Up to 8 simultaneously (in total across all ES clients)  No  8  Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job  200; per job  Yes  Peripheral inputs/outputs
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  Status/control variable  Variables  Number of variables, max.  of which status variables, max.  of which control variables, max.  Forcing  Forcing  Forcing  Forcing, variables  Number of variables, max.	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job 200; per job
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  Status/control variable  Variables  Number of variables, max.  of which status variables, max.  of which control variables, max.  Forcing  Forcing  Forcing  Forcing, variables  Number of variables, max.  Diagnostic buffer	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job 200; per job  Yes  Peripheral inputs/outputs 200
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  Status/control variable  Variables  Number of variables, max.  of which status variables, max.  of which control variables, max.  Forcing  Forcing  Forcing  Forcing, variables  Number of variables, max.  Jiagnostic buffer  present	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job 200; per job  Yes  Peripheral inputs/outputs 200  Yes
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  Status/control variable  Variables  Number of variables, max.  of which status variables, max.  of which control variables, max.  Forcing  Forcing  Forcing  Forcing, variables  Number of variables, max.  Diagnostic buffer  present  Number of entries, max.	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job 200; per job  Yes  Peripheral inputs/outputs 200
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  Status/control variable  Variables  Number of variables, max.  of which status variables, max.  of which control variables, max.  Forcing  Forcing  Forcing  Forcing, variables  Number of variables, max.  Jiagnostic buffer  present	Yes; Up to 8 simultaneously (in total across all ES clients) No 8 Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job 200; per job  Yes  Peripheral inputs/outputs 200  Yes
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  Status/control variable  Variables  Number of variables, max.  of which status variables, max.  of which control variables, max.  Forcing  Forcing  Forcing  Forcing, variables  Number of variables, max.  Diagnostic buffer  present  Number of entries, max.	Yes; Up to 8 simultaneously (in total across all ES clients)  No  8  Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job  200; per job  Yes  Peripheral inputs/outputs 200  Yes 1 000
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  Status/control variable  Variables  Number of variables, max.  of which status variables, max.  of which control variables, max.  Forcing  Forcing  Forcing  Forcing, variables  Number of variables, max.  Diagnostic buffer  present  Number of entries, max.  of which powerfail-proof	Yes; Up to 8 simultaneously (in total across all ES clients)  No  8  Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job  200; per job  Yes  Peripheral inputs/outputs 200  Yes 1 000
Joint commission (Team Engineering)  Status block  Single step  Number of breakpoints  Profiling  Status/control  Status/control variable  Variables  Number of variables, max.  of which status variables, max.  of which control variables, max.  Forcing  Forcing  Forcing  Forcing, variables  Number of variables, max.  Diagnostic buffer  present  Number of entries, max.  of which powerfail-proof	Yes; Up to 8 simultaneously (in total across all ES clients)  No  8  Yes  Yes  Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters  200; per job  200; per job  Yes  Peripheral inputs/outputs  200  Yes  1 000  500

Interrupts/diagnostics/status information	
Diagnostics indication LED	
RUN/STOP LED	Yes
• ERROR LED	Yes
• MAINT LED	Yes
STOP ACTIVE LED	Yes
<ul> <li>Connection display LINK TX/RX</li> </ul>	Yes
Supported technology objects	
Motion Control	Yes; Note: The number of technology objects affects the cycle time of the PLC
	program; selection guide via the TIA Selection Tool
<ul> <li>Number of available Motion Control resources for</li> </ul>	1 120
technology objects	
Required Motion Control resources	
— per speed-controlled axis	40
— per positioning axis	80
— per synchronous axis	160
— per external encoder	80
— per output cam	20
— per cam track	160
— per probe	40
Positioning axis     Number of positioning axes at motion control eveloperations.	11
<ul> <li>Number of positioning axes at motion control cycle of 4 ms (typical value)</li> </ul>	11
<ul> <li>Number of positioning axes at motion control cycle</li> </ul>	14
of 8 ms (typical value)	
Controller	
PID_Compact	Yes; Universal PID controller with integrated optimization
PID_3Step	Yes; PID controller with integrated optimization for valves
PID-Temp	Yes; PID controller with integrated optimization for temperature
Counting and measuring	
High-speed counter	Yes
Ambient conditions	
Ambient temperature during operation	
<ul> <li>horizontal installation, min.</li> </ul>	-30 °C; No condensation
<ul> <li>horizontal installation, max.</li> </ul>	60 °C; Display: 50 °C, at an operating temperature of typically 50 °C, the display is switched off
	display is switched off
• vertical installation, min.	display is switched off -30 °C; No condensation
	display is switched off
• vertical installation, min.	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the
<ul><li>vertical installation, min.</li><li>vertical installation, max.</li></ul>	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> </ul>	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off -40 °C
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul>	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off -40 °C
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul>	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> </ul>	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> <li>Programming language</li> </ul>	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> <li>Programming language</li> <li>LAD</li> </ul>	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> <li>Programming language</li> <li>LAD</li> <li>FBD</li> </ul>	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> </ul> Programming language <ul> <li>LAD</li> <li>FBD</li> <li>STL</li> </ul>	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes
vertical installation, min.     vertical installation, max.  Ambient temperature during storage/transportation     min.     max.  Altitude during operation relating to sea level     Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C 70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes
vertical installation, min.     vertical installation, max.  Ambient temperature during storage/transportation     min.     max.  Altitude during operation relating to sea level     Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — CFC	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes
vertical installation, min.     vertical installation, max.  Ambient temperature during storage/transportation     min.     max.  Altitude during operation relating to sea level     Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — CFC — GRAPH	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes
vertical installation, min.     vertical installation, max.  Ambient temperature during storage/transportation     min.     max.  Altitude during operation relating to sea level     Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — CFC — GRAPH  Know-how protection	display is switched off  -30 °C; No condensation  40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C  70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes Yes Yes Yes
vertical installation, min.     vertical installation, max.  Ambient temperature during storage/transportation     min.     max.  Altitude during operation relating to sea level     Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  LAD  FBD  STL  SCL  CFC  GRAPH  Know-how protection  User program protection/password protection	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C 70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes Yes Yes
vertical installation, min.     vertical installation, max.  Ambient temperature during storage/transportation     min.     max.  Altitude during operation relating to sea level     Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — CFC — GRAPH  Know-how protection  • User program protection/password protection • Copy protection • Block protection	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C 70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes Yes Yes Yes
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> </ul> Programming language <ul> <li>LAD</li> <li>FBD</li> <li>STL</li> <li>SCL</li> <li>CFC</li> <li>GRAPH</li> </ul> Know-how protection <ul> <li>User program protection/password protection</li> <li>Copy protection</li> <li>Block protection</li> </ul> Access protection Access protection	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C 70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes Yes Yes Yes
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> </ul> Programming language <ul> <li>LAD</li> <li>FBD</li> <li>STL</li> <li>SCL</li> <li>CFC</li> <li>GRAPH</li> </ul> Know-how protection <ul> <li>User program protection/password protection</li> <li>Copy protection</li> <li>Block protection</li> </ul> Access protection <ul> <li>protection of confidential configuration data</li> </ul>	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C 70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> </ul> Programming language <ul> <li>LAD</li> <li>FBD</li> <li>STL</li> <li>SCL</li> <li>CFC</li> <li>GRAPH</li> </ul> Know-how protection <ul> <li>User program protection/password protection</li> <li>Copy protection</li> <li>Block protection</li> </ul> Access protection <ul> <li>protection of confidential configuration data</li> <li>Password for display</li> </ul>	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C 70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
<ul> <li>vertical installation, min.</li> <li>vertical installation, max.</li> </ul> Ambient temperature during storage/transportation <ul> <li>min.</li> <li>max.</li> </ul> Altitude during operation relating to sea level <ul> <li>Installation altitude above sea level, max.</li> </ul> configuration / header <ul> <li>configuration / programming / header</li> </ul> Programming language <ul> <li>LAD</li> <li>FBD</li> <li>STL</li> <li>SCL</li> <li>CFC</li> <li>GRAPH</li> </ul> Know-how protection <ul> <li>User program protection/password protection</li> <li>Copy protection</li> <li>Block protection</li> </ul> Access protection <ul> <li>protection of confidential configuration data</li> </ul>	display is switched off -30 °C; No condensation 40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off  -40 °C 70 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye

Protection level: Write protection for Failsafe	No
Protection level: Complete protection	Yes
<ul> <li>User administration</li> </ul>	Yes; device-wide
programming / cycle time monitoring / header	
<ul><li>lower limit</li></ul>	adjustable minimum cycle time
• upper limit	adjustable maximum cycle time
Dimensions	
Width	35 mm
Height	147 mm
Depth	129 mm
Weights	
Weight, approx.	336 g

last modified:

